



RF360
Europe GmbH

SAW components

SAW duplexer

Small cell & femtocell
LTE band 3

Series/type:	B8044
Ordering code:	B39182B8044P810
Date:	September 29, 2017
Version:	2.1

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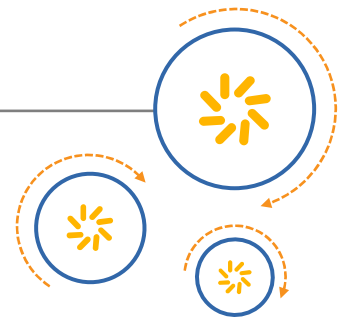
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Data sheet

1 Application

- Low-loss SAW duplexer for LTE small cell & femtocell systems (Band 3)
- Usable pass band 75 MHz
- Rx = uplink = 1710 MHz – 1785 MHz
- Tx = downlink = 1805 MHz – 1880 MHz

2 Features

- Industrial grade qualified family
- Package size 2.5 ± 0.1 mm \times 2.0 ± 0.1 mm
- Package height 0.5 mm (max.)
- Approximate weight 0.01 g
- RoHS compatible
- Package for Surface Mount Technology (SMT)
- Ni/Au-plated terminals
- Electrostatic Sensitive Device (ESD)
- Moisture Sensitivity Level 2a (MSL2a)

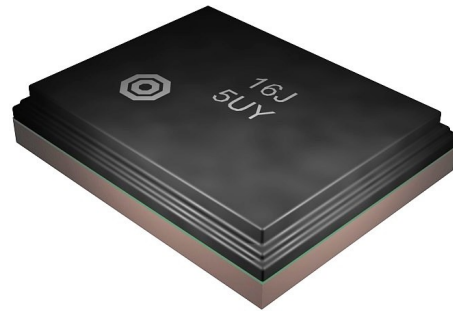


Figure 1: Picture of component with example of product marking.

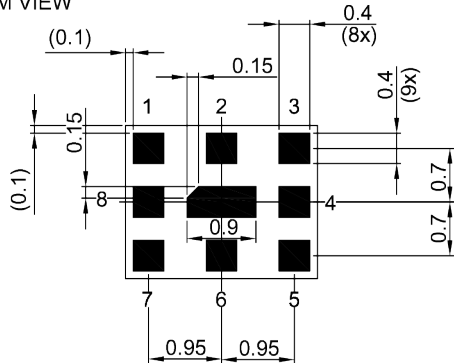
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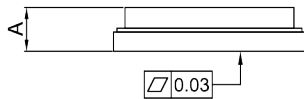
3 Package

BOTTOM VIEW

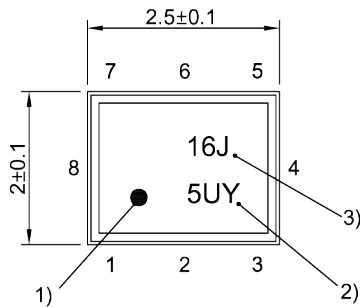


Pad and pitch tolerance ±0.05

SIDE VIEW

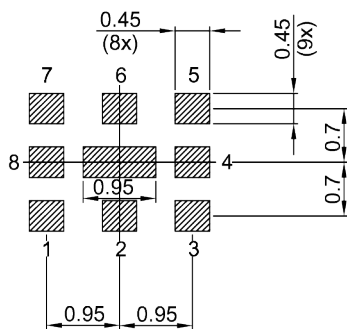


TOP VIEW



- 1) Marking for pad number 1
- 2) Example of encoded lot number
- 3) Example of encoded filter type number

Land pattern THRU VIEW



Landing pad tolerance -0.02

Figure 2: Drawing of package with package height A = 0.5 mm (max.). See Sec. Package information (p. 27).

4 Pin configuration

- 1 TX
- 3 RX
- 6 ANT
- 2, 4, 5, 7, 8, 9 Ground

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5 Matching circuit

■ $L_{p1} = 3.6 \text{ nH}$

■ $L_{p6} = 3.0 \text{ nH}$

■ $L_{p3} = 7.5 \text{ nH}$

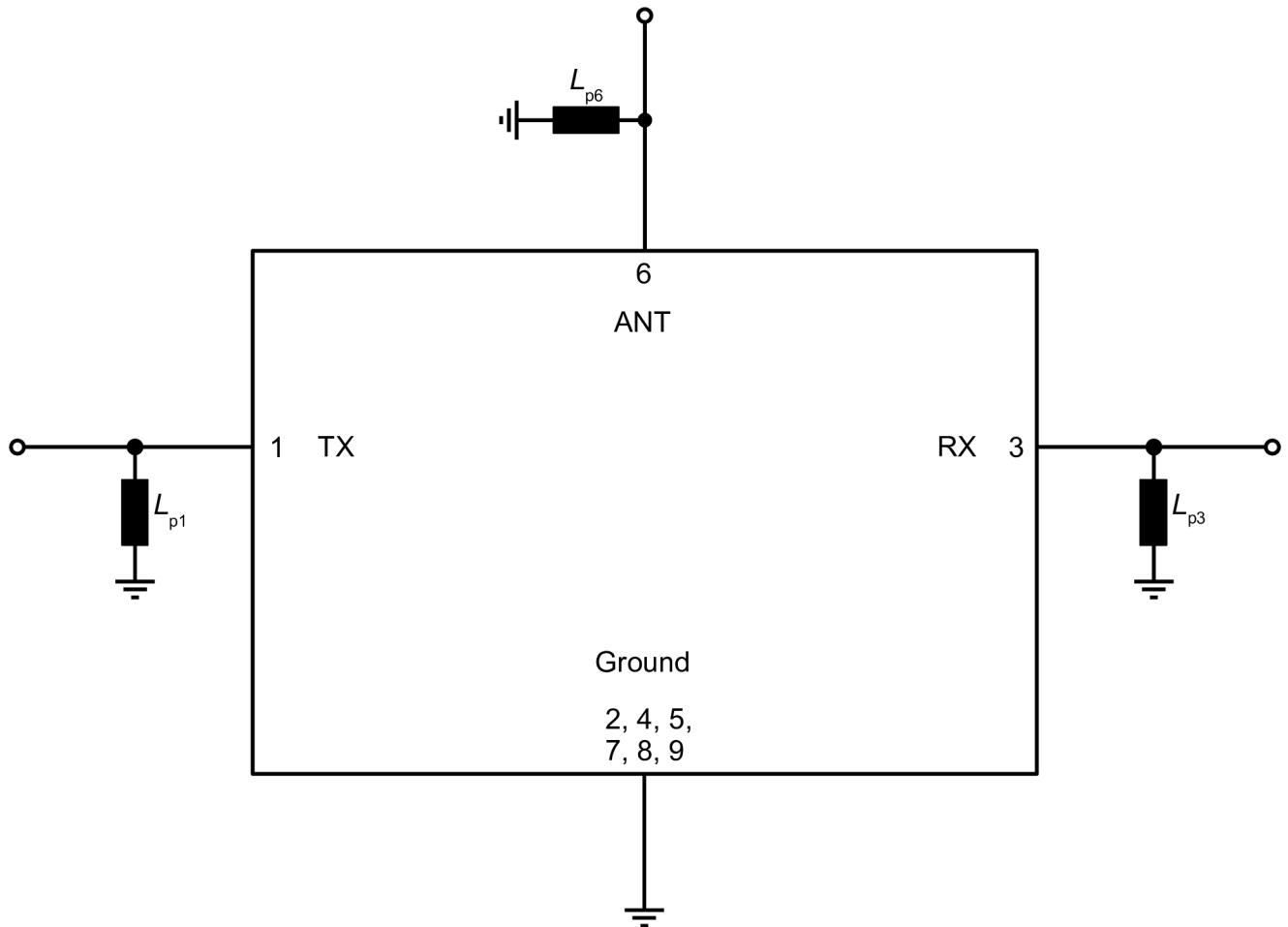


Figure 3: Schematic of matching circuit.

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SAW duplexer

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6 Characteristics

6.1 TX – ANT

Temperature range for specification	T_{SPEC}	= -10 °C ... +85 °C
TX terminating impedance	Z_{TX}	= 50 Ω with par. 3.6 nH ¹⁾
ANT terminating impedance	Z_{ANT}	= 50 Ω with par. 3.0 nH ¹⁾
RX terminating impedance	Z_{RX}	= 50 Ω with par. 7.5 nH ¹⁾

Characteristics TX – ANT				min. for T_{SPEC}	typ. @ +25 °C	max. for T_{SPEC}	
Center frequency			f_C	—	1842.5	—	MHz
Average insertion attenuation			$\alpha_{INT,avg}$ ²⁾				
	1805... 1810	MHz		—	2.2	3.3	dB
	1810... 1875	MHz		—	1.9	2.8	dB
	1875... 1880	MHz		—	1.6	2.7	dB
Maximum insertion attenuation			α_{max}				
	1805... 1880	MHz		—	2.7	4.0	dB
	1840... 1870	MHz		—	1.4	2.5	dB
Amplitude ripple (p-p)			$\Delta\alpha$				
	1805... 1880	MHz		—	1.7	3.0	dB
	1840... 1870	MHz		—	0.4	1.0	dB
Maximum VSWR			VSWR _{max}				
@ TX port	1805... 1880	MHz		—	1.7	2.0	
@ ANT port	1805... 1880	MHz		—	1.7	2.0	
Maximum error vector magnitude			EVM _{max} ³⁾				
	1807.4... 1877.6	MHz		—	2.0	3.5	%
Minimum attenuation			α_{min}				
	10... 1710	MHz		30	38	—	dB
	1710... 1745	MHz		42	50	—	dB
	1745... 1775	MHz		45	52	—	dB
	1775... 1783	MHz		45	52	—	dB
	1783... 1785	MHz		35	51	—	dB
	1900... 1911	MHz		5	38	—	dB
	1911... 1920	MHz		35	56	—	dB
	1920... 1980	MHz		40	50	—	dB
	1980... 2250	MHz		35	45	—	dB
	2250... 2425	MHz		15	23	—	dB
	2425... 3740	MHz		35	50	—	dB
	3740... 5725	MHz		30	44	—	dB

¹⁾ See Sec. Matching circuit (p. 6).

²⁾ Integrated attenuation α_{INT} : Averaged power $|S_{ij}|^2$ over the center 4.5 MHz of LTE 5 MHz (25 RB) channels.

³⁾ Error Vector Magnitude (EVM) based on definition in 3GPP TS 25.141.

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Temperature range for specification	T_{SPEC}	= -40 °C ... +95 °C
TX terminating impedance	Z_{TX}	= 50 Ω with par. 3.6 nH ¹⁾
ANT terminating impedance	Z_{ANT}	= 50 Ω with par. 3.0 nH ¹⁾
RX terminating impedance	Z_{RX}	= 50 Ω with par. 7.5 nH ¹⁾

Characteristics TX – ANT				min. for T_{SPEC}	typ. @ +25 °C	max. for T_{SPEC}	
Average insertion attenuation	$\alpha_{INT,avg}$ ²⁾	1805... 1810 MHz	—	2.2	4.5	dB	
		1810... 1875 MHz	—	1.9	3.5	dB	
		1875... 1880 MHz	—	1.6	3.2	dB	
Maximum insertion attenuation	α_{max}	1805... 1880 MHz	—	2.7	6.2	dB	
		1840... 1870 MHz	—	1.4	2.7	dB	
Amplitude ripple (p-p)	$\Delta\alpha$	1805... 1880 MHz	—	1.7	5.2	dB	
		1840... 1870 MHz	—	0.4	1.2	dB	
Maximum VSWR	VSWR _{max}	@ TX port	1805... 1880 MHz	—	1.7	2.5	
		@ ANT port	1805... 1880 MHz	—	1.7	2.5	
Maximum error vector magnitude	EVM _{max} ³⁾	1807.4... 1877.6 MHz	—	2.0	7.0	%	
Minimum attenuation	α_{min}	10... 1710 MHz	30	38	—	dB	
		1710... 1745 MHz	40	50	—	dB	
		1745... 1775 MHz	45	52	—	dB	
		1775... 1783 MHz	40	52	—	dB	
		1783... 1785 MHz	30	51	—	dB	
		1900... 1911 MHz	3	38	—	dB	
		1911... 1920 MHz	35	56	—	dB	
		1920... 1980 MHz	40	50	—	dB	
		1980... 2250 MHz	35	45	—	dB	
		2250... 2425 MHz	15	23	—	dB	
		2425... 3740 MHz	35	50	—	dB	
		3740... 5725 MHz	30	44	—	dB	

¹⁾ See Sec. Matching circuit (p. 6).

²⁾ Integrated attenuation α_{INT} : Averaged power $|S_{ij}|^2$ over the center 4.5 MHz of LTE 5 MHz (25 RB) channels.

³⁾ Error Vector Magnitude (EVM) based on definition in 3GPP TS 25.141.

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6.2 ANT – RX

Temperature range for specification	T_{SPEC}	= -10 °C ... +85 °C
TX terminating impedance	Z_{TX}	= 50 Ω with par. 3.6 nH ¹⁾
ANT terminating impedance	Z_{ANT}	= 50 Ω with par. 3.0 nH ¹⁾
RX terminating impedance	Z_{RX}	= 50 Ω with par. 7.5 nH ¹⁾

Characteristics ANT – RX				min. for T_{SPEC}	typ. @ +25 °C	max. for T_{SPEC}	
Center frequency			f_C	—	1747.5	—	MHz
Average insertion attenuation			$\alpha_{INT,avg}$ ²⁾				
	1710... 1715	MHz		—	3.2	4.3	dB
	1715... 1780	MHz		—	2.7	3.5	dB
	1780... 1785	MHz		—	2.2	4.3	dB
Maximum insertion attenuation			α_{max}				
	1710... 1785	MHz		—	3.8	5.3	dB
	1745... 1775	MHz		—	1.6	3.0	dB
Amplitude ripple (p-p)			$\Delta\alpha$				
	1710... 1785	MHz		—	1.5	4.0	dB
	1745... 1775	MHz		—	0.3	1.5	dB
Maximum VSWR			VSWR _{max}				
@ ANT port	1710... 1785	MHz		—	1.7	2.1	
@ RX port	1710... 1785	MHz		—	1.6	2.0	
Maximum error vector magnitude			EVM _{max} ³⁾				
	1712.4... 1782.6	MHz		—	2.4	4.9	%
Minimum attenuation			α_{min}				
	10... 1660	MHz		40	42	—	dB
	1660... 1690	MHz		30	36	—	dB
	1805... 1840	MHz		40	65	—	dB
	1840... 1880	MHz		45	57	—	dB
	1880... 2400	MHz		40	43	—	dB
	2400... 2500	MHz		40	42	—	dB
	2500... 3550	MHz		35	38	—	dB
	3550... 4200	MHz		32	36	—	dB
	4200... 5325	MHz		28	34	—	dB

¹⁾ See Sec. Matching circuit (p. 6).

²⁾ Integrated attenuation α_{INT} : Averaged power $|S_{ij}|^2$ over the center 4.5 MHz of LTE 5 MHz (25 RB) channels.

³⁾ Error Vector Magnitude (EVM) based on definition in 3GPP TS 25.141.

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Temperature range for specification	T_{SPEC}	= -40 °C ... +95 °C
TX terminating impedance	Z_{TX}	= 50 Ω with par. 3.6 nH ¹⁾
ANT terminating impedance	Z_{ANT}	= 50 Ω with par. 3.0 nH ¹⁾
RX terminating impedance	Z_{RX}	= 50 Ω with par. 7.5 nH ¹⁾

Characteristics ANT – RX			min. for T_{SPEC}	typ. @ +25 °C	max. for T_{SPEC}		
Average insertion attenuation		$\alpha_{INT,avg}$ ²⁾	—	3.2	5.5	dB	
			1710... 1715 MHz	—	2.7		3.8
			1715... 1780 MHz	—	2.2		5.0
Maximum insertion attenuation		α_{max}	—	3.8	7.5	dB	
			1745... 1775 MHz	—	1.6		3.2
Amplitude ripple (p-p)		$\Delta\alpha$	—	1.5	6.3	dB	
			1745... 1775 MHz	—	0.3		1.7
Maximum VSWR		VSWR _{max}	—	1.7	2.5		
			@ ANT port	1710... 1785 MHz	—		1.6
	@ RX port	1710... 1785 MHz	—	1.6	2.5		
Maximum error vector magnitude		EVM _{max} ³⁾	—	2.4	9.0	%	
	1712.4... 1782.6 MHz						
Minimum attenuation		α_{min}	40	42	—	dB	
			10... 1660 MHz	27	36		—
			1660... 1690 MHz	30	65		—
			1805... 1840 MHz	45	57		—
			1840... 1880 MHz	40	43		—
			1880... 2400 MHz	40	42		—
			2400... 2500 MHz	35	38		—
			2500... 3550 MHz	32	36		—
			3550... 4200 MHz	28	34		—
			4200... 5325 MHz				

¹⁾ See Sec. Matching circuit (p. 6).

²⁾ Integrated attenuation α_{INT} : Averaged power $|S_{ij}|^2$ over the center 4.5 MHz of LTE 5 MHz (25 RB) channels.

³⁾ Error Vector Magnitude (EVM) based on definition in 3GPP TS 25.141.

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Temperature range for specification	T_{SPEC}	= -40 °C ... +95 °C
TX terminating impedance	Z_{TX}	= 50 Ω with par. 3.6 nH ¹⁾
ANT terminating impedance	Z_{ANT}	= 50 Ω with par. 3.0 nH ¹⁾
RX terminating impedance	Z_{RX}	= 50 Ω with par. 7.5 nH ¹⁾

Characteristics TX – RX				min. for T_{SPEC}	typ. @ +25 °C	max. for T_{SPEC}		
Average isolation			$\alpha_{INT,avg}$ ²⁾					
			1710... 1712 MHz	45	53	—	dB	
			1712... 1782 MHz	50	53	—	dB	
			1782... 1785 MHz	45	59	—	dB	
		1805... 1880 MHz	50	59	—	dB		
Minimum isolation			α_{min}					
				1710... 1712 MHz	48	55	—	dB
				1710... 1712 MHz	50 ³⁾	55	—	dB
				1712... 1782 MHz	50	53	—	dB
				1782... 1785 MHz	40	55	—	dB
		1805... 1880 MHz	50	59	—	dB		

¹⁾ See Sec. Matching circuit (p. 6).

²⁾ Integrated attenuation α_{INT} : Averaged power $|S_{ij}|^2$ over the center 4.5 MHz of LTE 5 MHz (25 RB) channels.

³⁾ Valid for temperature $T = +25$ °C...+95 °C.

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7 Maximum ratings

Operable temperature	$T_{OP} = -40\text{ °C} \dots +95\text{ °C}$	
Storage temperature	$T_{STG}^{1)} = -40\text{ °C} \dots +95\text{ °C}$	
DC voltage	$ V_{DC} ^{2)} = 0\text{ V}$	
ESD voltage		
	$V_{ESD}^{3)} = 375\text{ V}$	Machine model.
	$V_{ESD}^{4)} = 800\text{ V}$	Human body model.
Input power @ TX port: 1805 ... 1880 MHz	$P_{IN} = 28\text{ dBm}^{5), 6)}$	5 MHz LTE downlink signal for 100000 h @ 55 °C. P_{IN} average – 39 dBm peak. Source and load impedance 50Ω.

¹⁾ Not valid for packaging material. Storage temperature for packaging material is –25 °C to +40 °C.

²⁾ In case of applied DC voltage blocking capacitors are mandatory.

³⁾ According to JESD22-A115B (MM – Machine Model), 10 negative & 10 positive pulses.

⁴⁾ According to JESD22-A114F (HBM – Human Body Model), 1 negative & 1 positive pulse.

⁵⁾ Expected lifetime according to accelerated power durability tests, and wear out models.

⁶⁾ T_{SPEC} is the ambient temperature of the PCB at component position. Specified min./max values from section 6 "characteristics" for maximum input power 28 dBm are valid for temperature up to 55 °C.

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8 Transmission coefficients

8.1 TX – ANT

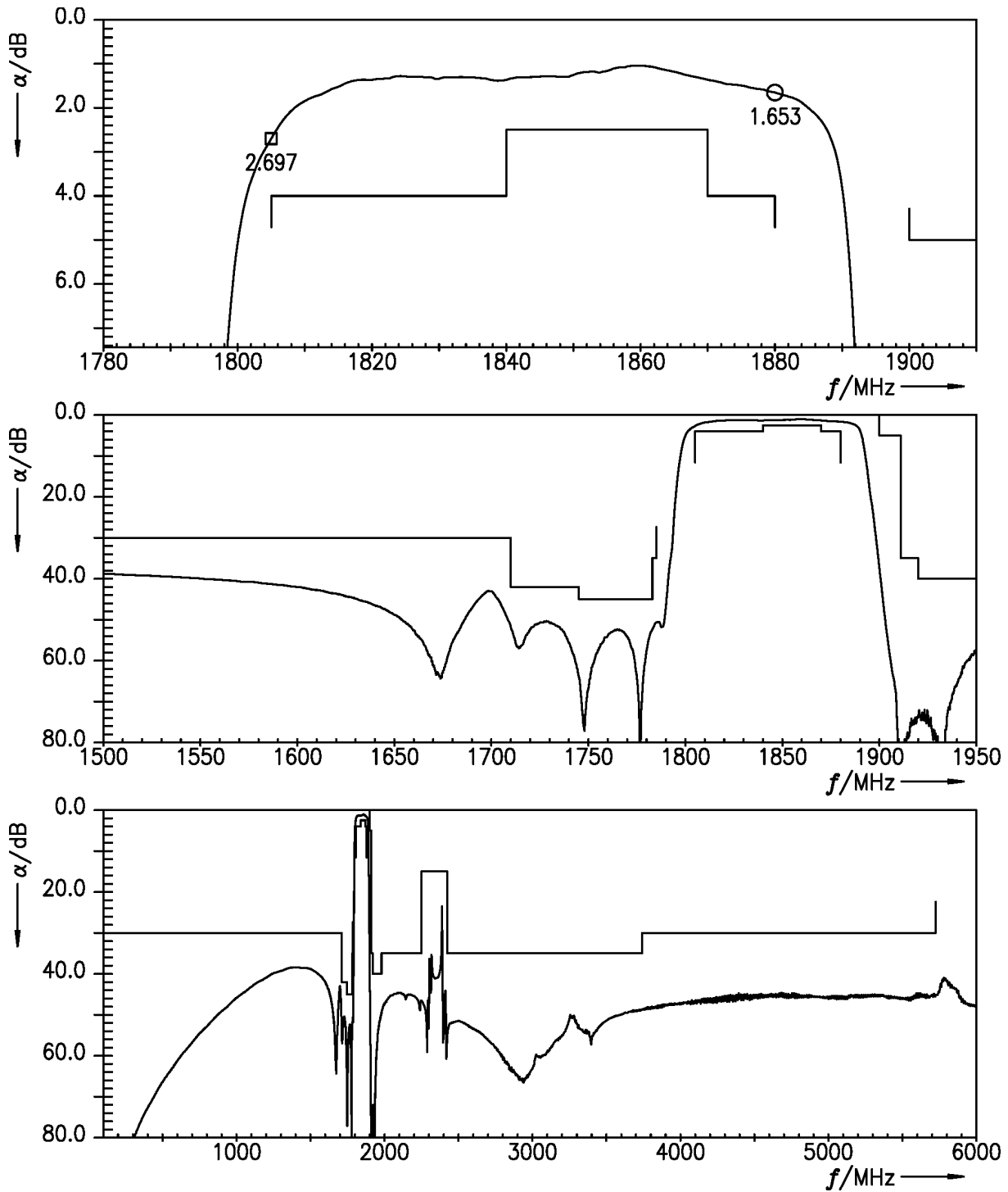


Figure 4: Attenuation TX – ANT.

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8.2 ANT – RX

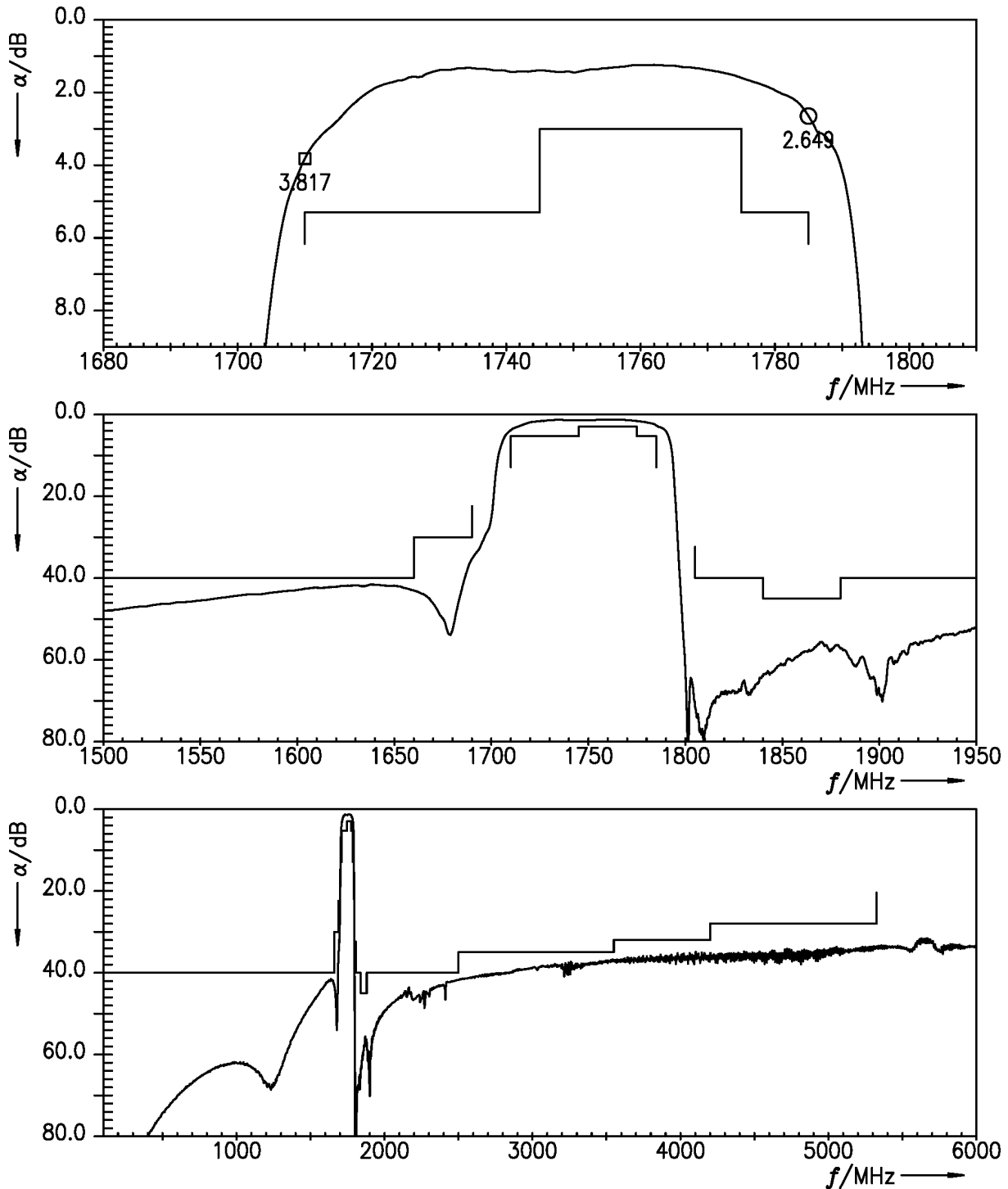


Figure 5: Attenuation ANT – RX.

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8.3 TX – RX

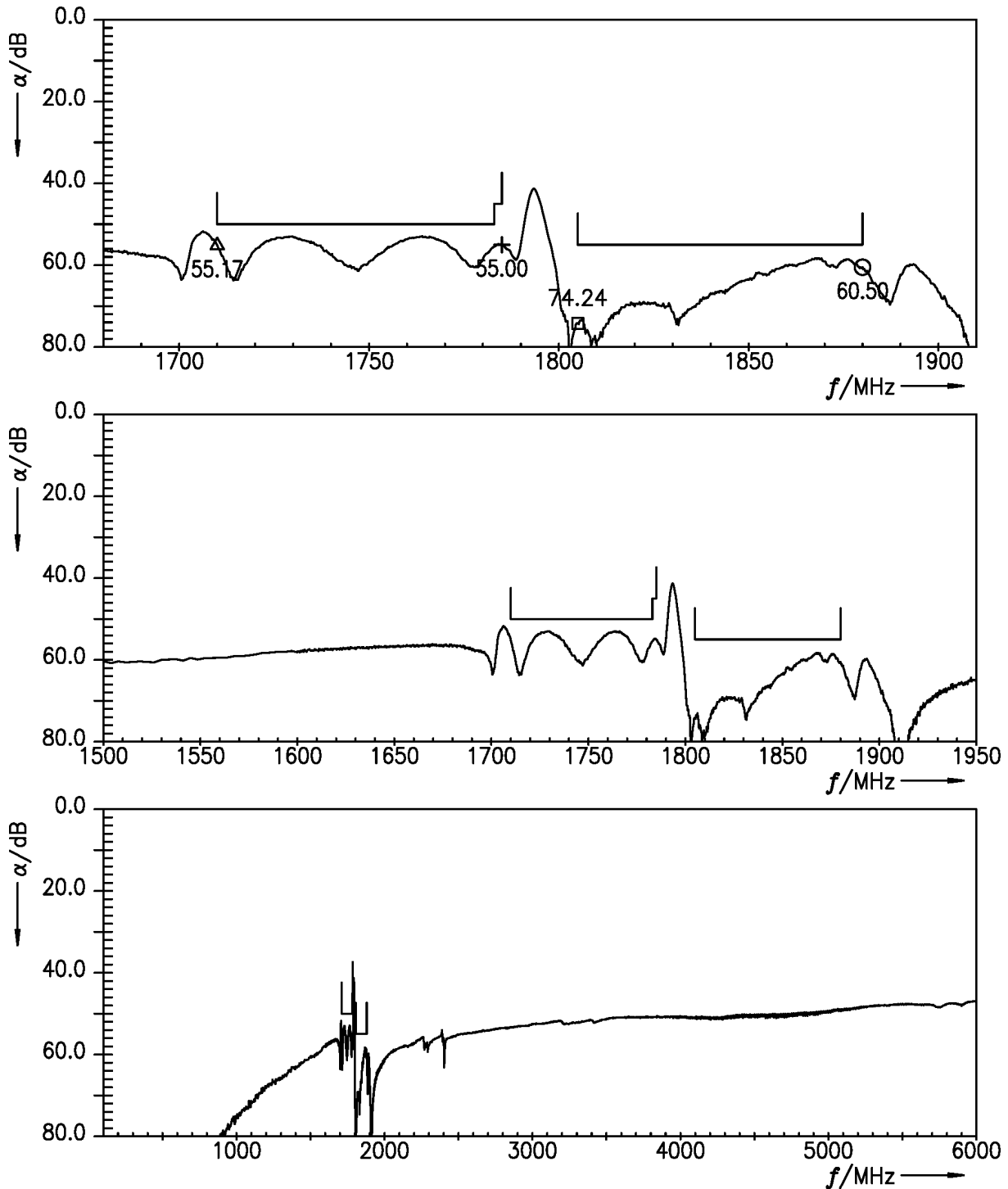


Figure 6: Isolation TX – RX.

Data sheet

9 Reflection coefficients

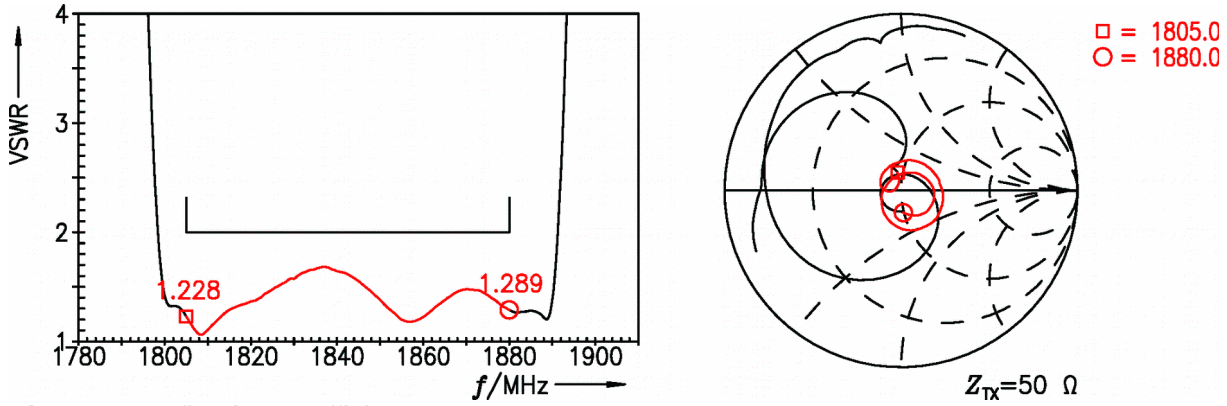


Figure 7: Reflection coefficient at TX port.

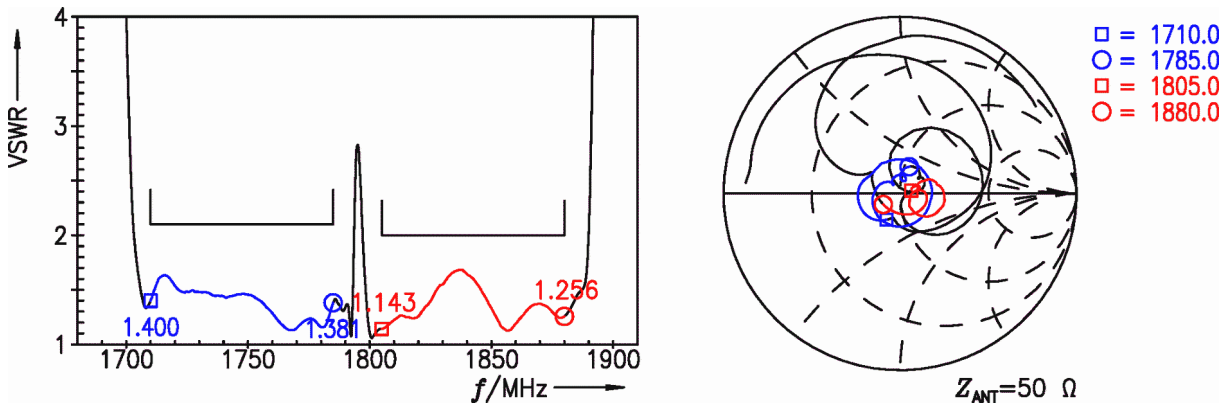


Figure 8: Reflection coefficient at ANT port.

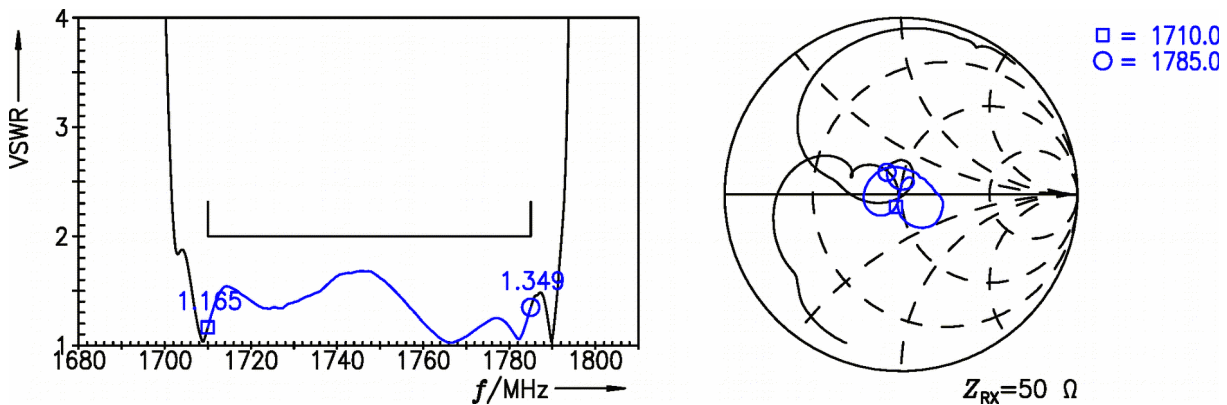


Figure 9: Reflection coefficient at RX port.

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10 EVMs

10.1 TX – ANT

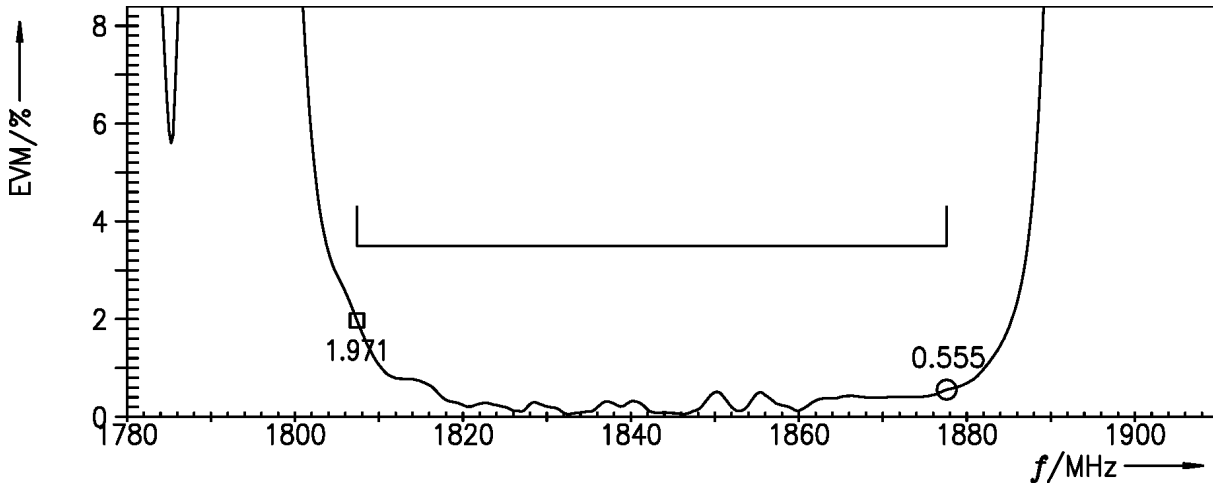


Figure 10: Error vector magnitude TX – ANT.

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10.2 ANT – RX

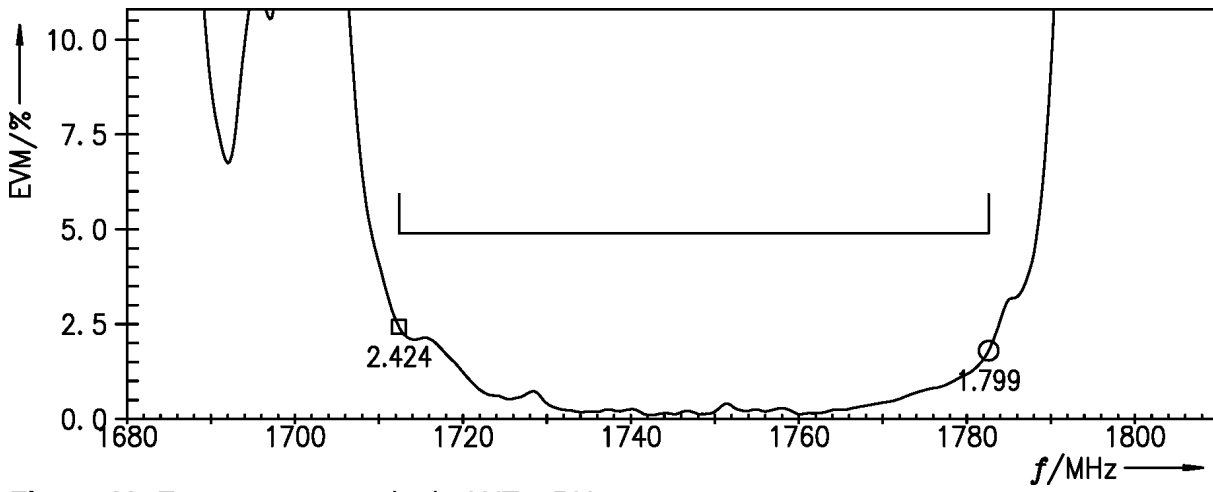


Figure 11: Error vector magnitude ANT – RX.

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11 Packing material

11.1 Tape

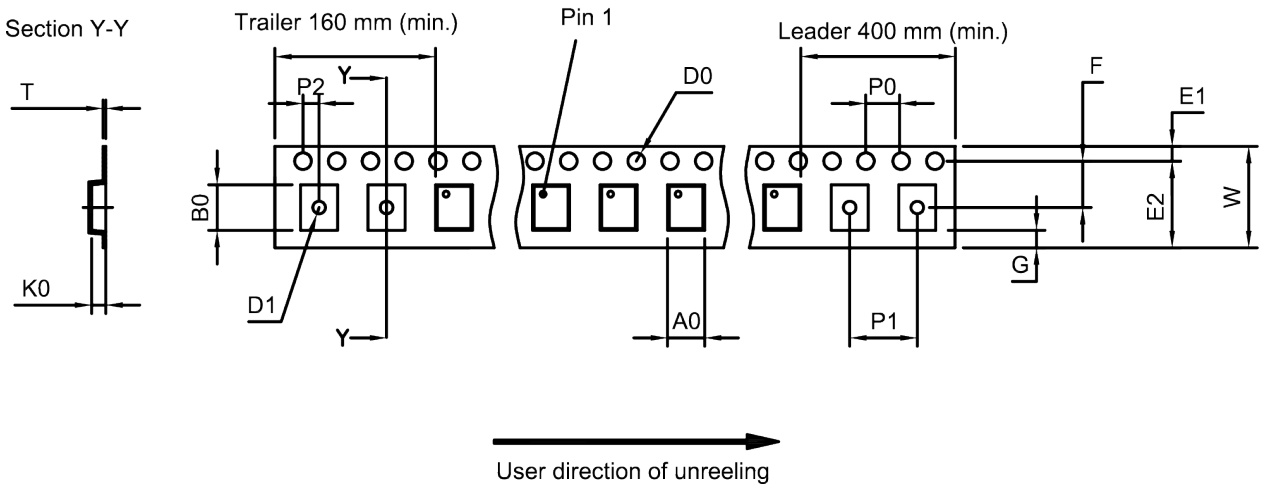


Figure 12: Drawing of tape (first-angle projection) with tape dimensions according to Table 1.

A ₀	2.25±0.05 mm	E ₂	6.25 mm (min.)	P ₁	4.0±0.1 mm
B ₀	2.75±0.05 mm	F	3.5±0.05 mm	P ₂	2.0±0.05 mm
D ₀	1.5+0.1/-0 mm	G	0.75 mm (min.)	T	0.25±0.03 mm
D ₁	1.0 mm (min.)	K ₀	0.6±0.05 mm	W	8.0+0.3/-0.1 mm
E ₁	1.75±0.1 mm	P ₀	4.0±0.1 mm		

Table 1: Tape dimensions.

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11.2 Reel with diameter of 180 mm

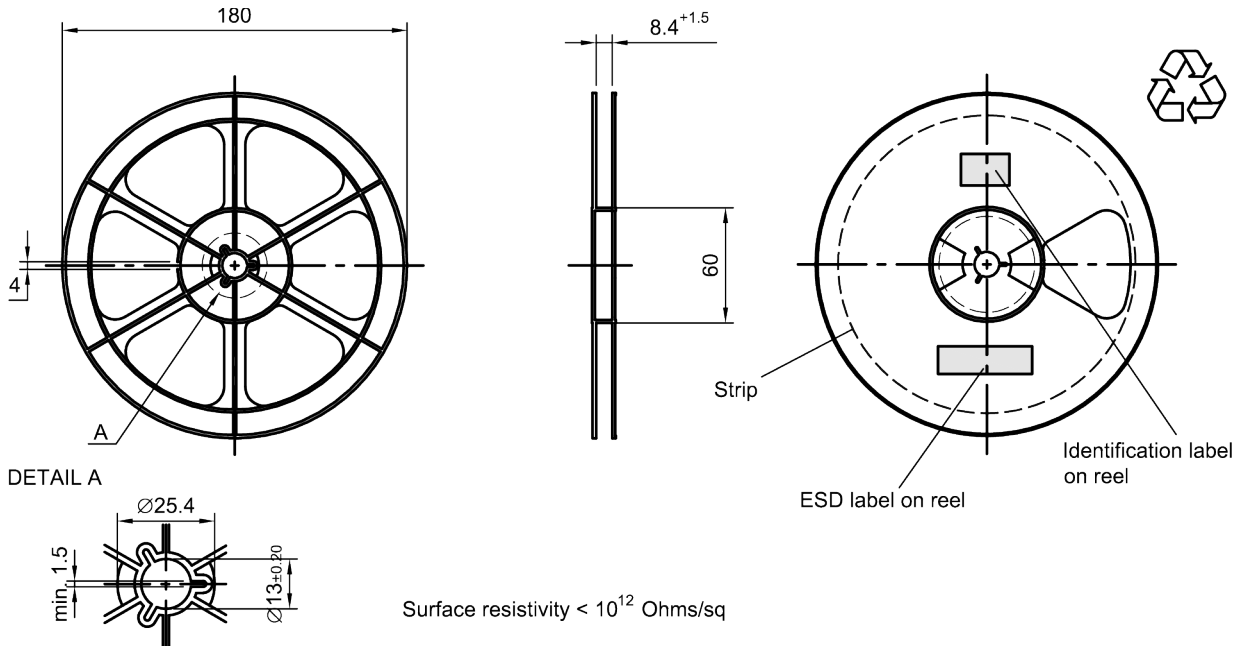


Figure 13: Drawing of reel (first-angle projection) with diameter of 180 mm.

Dimensions [mm]

X = 220+5

Y = 235+5

Sealing area 10±3

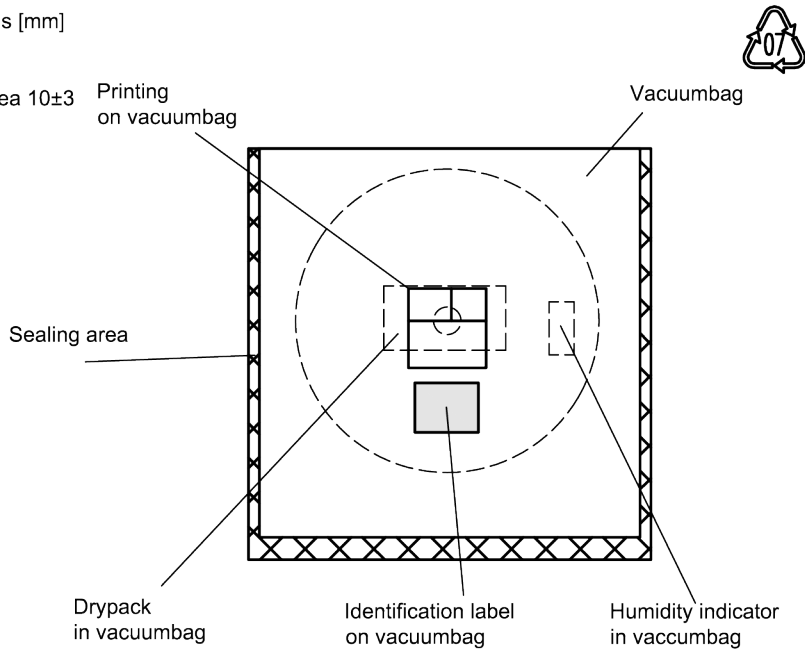


Figure 14: Drawing of moisture barrier bag (MBB) for reel with diameter of 180 mm.

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Dimensions [mm]
 L = 188
 B = 188
 H = 30
 Tolerance ±5

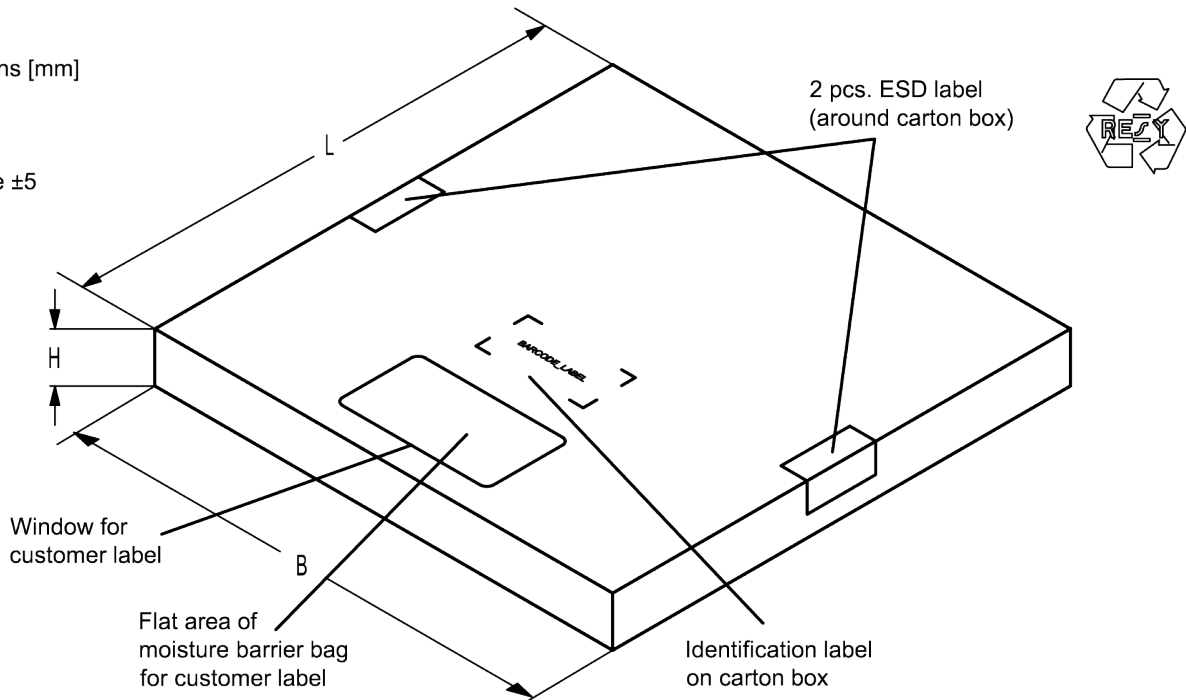


Figure 15: Drawing of folding box for reel with diameter of 180 mm.

11.3 Reel with diameter of 330 mm

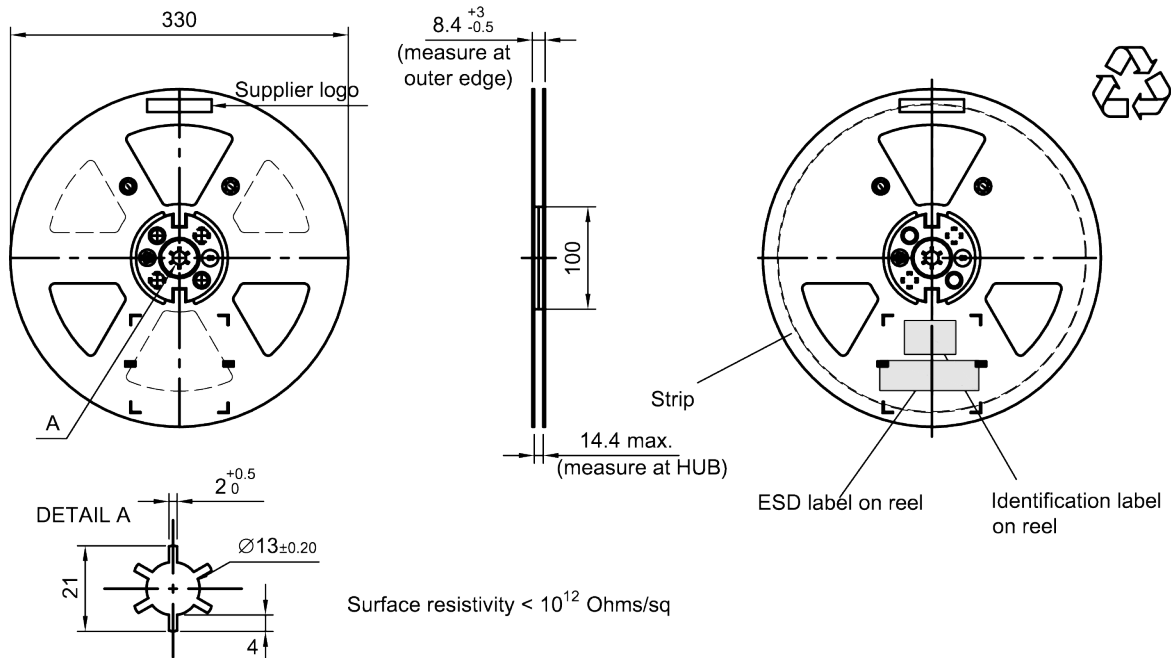


Figure 16: Drawing of reel (first-angle projection) with diameter of 330 mm.

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Dimensions [mm]
 X = 400+5
 Y = 418+5
 Sealing area 10±3

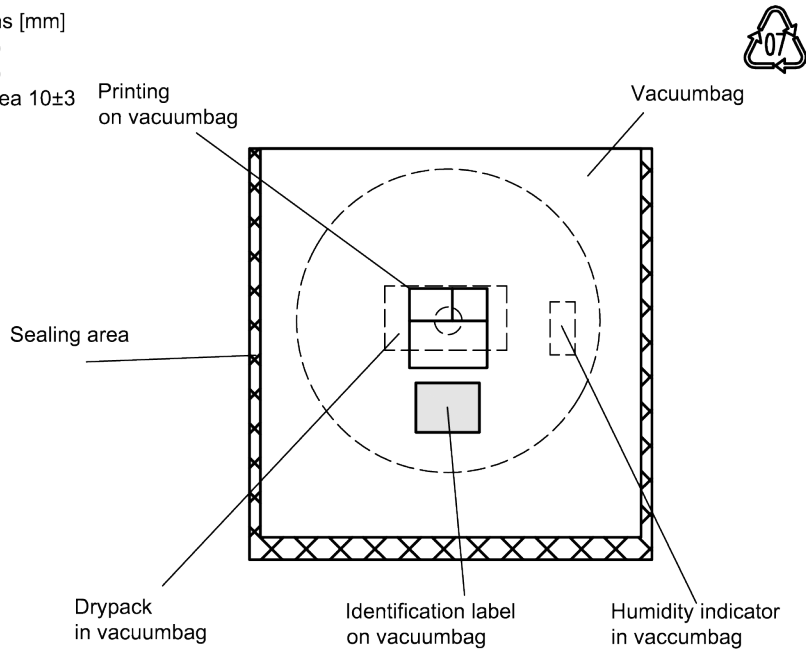


Figure 17: Drawing of moisture barrier bag (MBB) for reel with diameter of 330 mm.

Dimensions [mm]
 L = 335
 B = 338
 H = 36 (for 8 mm tape width)
 40 (for 12 mm tape width)
 Tolerance ±5

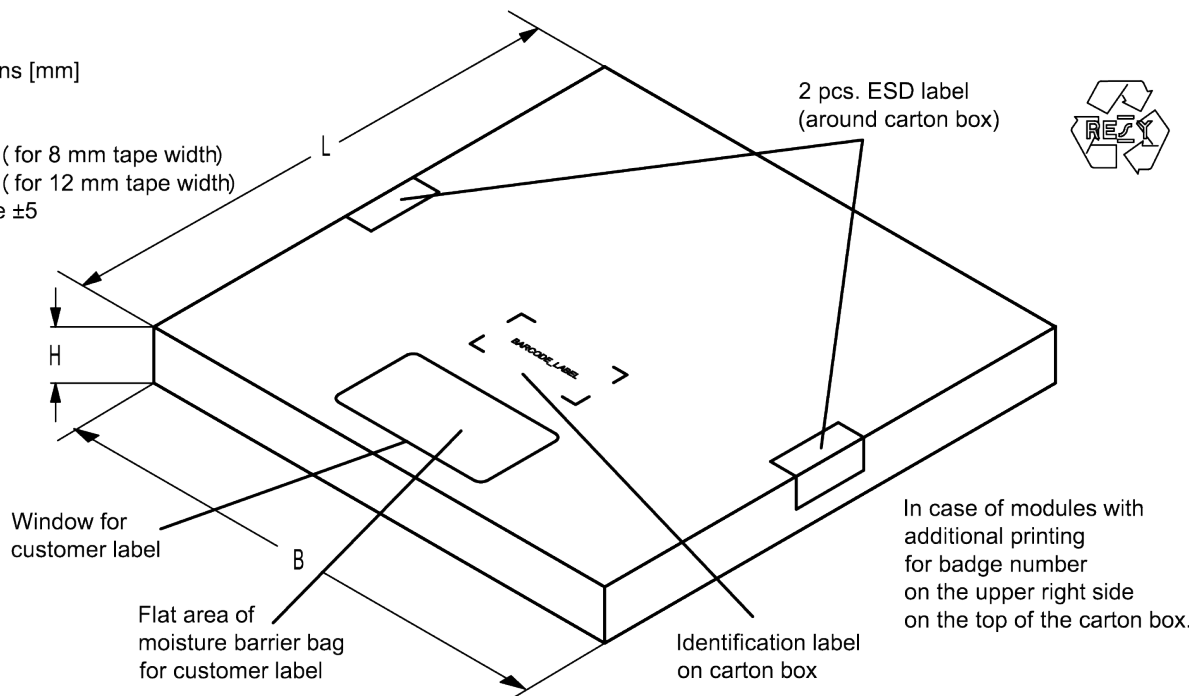


Figure 18: Drawing of folding box for reel with diameter of 330 mm.

SAW components	B8044
SAW duplexer	1747.5 / 1842.5 MHz

Data sheet

12 Marking

Products are marked with product type number and lot number encoded according to Table 2:

■ Type number:

The 4 digit type number of the ordering code, e.g., B3xxxxB**1234**xxxx, is encoded by a special BASE32 code into a 3 digit marking.

Example of decoding	type number marking on device	in decimal code.
	16J	1234
	$1 \times 32^2 + 6 \times 32^1 + 18 (=J) \times 32^0$	1234

The BASE32 code for product type B8044 is 7VC.

■ Lot number:

The last 5 digits of the lot number, e.g., **12345**, are encoded based on a special BASE47 code into a 3 digit marking.

Example of decoding lot number marking on device		in decimal code.
	5UY	12345
	$5 \times 47^2 + 27 (=U) \times 47^1 + 31 (=Y) \times 47^0$	12345

Adopted BASE32 code for type number			
Decimal value	Base32 code	Decimal value	Base32 code
0	0	16	G
1	1	17	H
2	2	18	J
3	3	19	K
4	4	20	M
5	5	21	N
6	6	22	P
7	7	23	Q
8	8	24	R
9	9	25	S
10	A	26	T
11	B	27	V
12	C	28	W
13	D	29	X
14	E	30	Y
15	F	31	Z

Adopted BASE47 code for lot number			
Decimal value	Base47 code	Decimal value	Base47 code
0	0	24	R
1	1	25	S
2	2	26	T
3	3	27	U
4	4	28	V
5	5	29	W
6	6	30	X
7	7	31	Y
8	8	32	Z
9	9	33	b
10	A	34	d
11	B	35	f
12	C	36	h
13	D	37	n
14	E	38	r
15	F	39	t
16	G	40	v
17	H	41	\
18	J	42	?
19	K	43	{
20	L	44	}
21	M	45	<
22	N	46	>
23	P		

Table 2: Lists for encoding and decoding of marking.

Data sheet

13 Soldering profile

The recommended soldering process is in accordance with IEC 60068-2-58 – 3rd edit and IPC/JEDEC J-STD-020B.

ramp rate	≤ 3 K/s
preheat	125 °C to 220 °C, 150 s to 210 s, 0.4 K/s to 1.0 K/s
$T > 220$ °C	30 s to 70 s
$T > 230$ °C	min. 10 s
$T > 245$ °C	max. 20 s
$T \geq 255$ °C	–
peak temperature T_{peak}	250 °C +0/-5 °C
wetting temperature T_{min}	230 °C +5/-0 °C for 10 s ± 1 s
cooling rate	≤ 3 K/s
soldering temperature T	measured at solder pads

Table 3: Characteristics of recommended soldering profile for lead-free solder (Sn95.5Ag3.8Cu0.7).

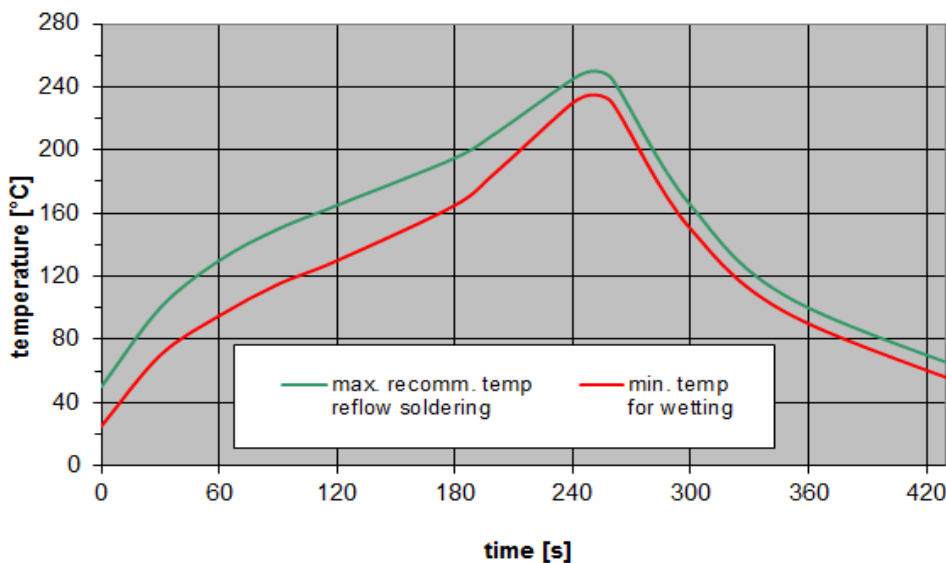


Figure 19: Recommended reflow profile for convection and infrared soldering – lead-free solder.

Data sheet

14 Annotations

14.1 Matching coils

See TDK inductor pdf-catalog <http://www.tdk.co.jp/tefe02/coil.htm#aname1> and Data Library for circuit simulation <http://www.tdk.co.jp/etvcl/index.htm>.

14.2 RoHS compatibility

ROHS-compatible means that products are compatible with the requirements according to Art. 4 (substance restrictions) of Directive 2011/65/EU of the European Parliament and of the Council of June 8th, 2011, on the restriction of the use of certain hazardous substances in electrical and electronic equipment ("Directive") with due regard to the application of exemptions as per Annex III of the Directive in certain cases.

14.3 Scattering parameters (S-parameters)

The pin/port assignment is available in the headers of the S-parameter files. Please contact your local RF360 sales office.

14.4 Ordering codes and packing units

Ordering code	Packing unit
B39182B8044P810	5000 pcs

Table 4: Ordering codes and packing units.

Data sheet

15 Cautions and warnings

15.1 Display of ordering codes for RF360 products

The ordering code for one and the same product can be represented differently in data sheets, data books, other publications and the website of RF360, or in order-related documents such as shipping notes, order confirmations and product labels. The varying representations of the ordering codes are due to different processes employed and do not affect the specifications of the respective products. Detailed information can be found on the Internet under www.rf360jv.com/orderingcodes.

15.2 Material information

Due to technical requirements components may contain dangerous substances. For information on the type in question please also contact one of our sales offices.

For information on recycling of tapes and reels please contact one of our sales offices.

15.3 Moldability

Before using in overmolding environment, please contact your local RF360 sales office.

15.4 Package information

Landing area

The printed circuit board (PCB) land pattern (landing area) shown is based on RF360 internal development and empirical data and illustrated for example purposes, only. As customers' SMD assembly processes may have a plenty of variants and influence factors which are not under control or knowledge of RF360, additional careful process development on customer side is necessary and strongly recommended in order to achieve best soldering results tailored to the particular customer needs.

Dimensions

Unless otherwise specified all dimensions are understood using unit millimeter (mm).

Dimensions do not include burrs.

Projection method

Unless otherwise specified first-angle projection is applied.

Important notes

The following applies to all products named in this publication:

1. Some parts of this publication contain **statements about the suitability of our products for certain areas of application**. These statements are based on our knowledge of typical requirements that are often placed on our products in the areas of application concerned. We nevertheless expressly point out **that such statements cannot be regarded as binding statements about the suitability of our products for a particular customer application**. As a rule, RF360 Europe GmbH and its affiliates are either unfamiliar with individual customer applications or less familiar with them than the customers themselves. For these reasons, it is always ultimately incumbent on the customer to check and decide whether an RF360 product with the properties described in the product specification is suitable for use in a particular customer application.
2. We also point out that **in individual cases, a malfunction of electronic components or failure before the end of their usual service life cannot be completely ruled out in the current state of the art, even if they are operated as specified**. In customer applications requiring a very high level of operational safety and especially in customer applications in which the malfunction or failure of an electronic component could endanger human life or health (e.g. in accident prevention or life-saving systems), it must therefore be ensured by means of suitable design of the customer application or other action taken by the customer (e.g. installation of protective circuitry or redundancy) that no injury or damage is sustained by third parties in the event of malfunction or failure of an electronic component.
3. **The warnings, cautions and product-specific notes must be observed.**
4. In order to satisfy certain technical requirements, **some of the products described in this publication may contain substances subject to restrictions in certain jurisdictions (e.g. because they are classed as hazardous)**. Useful information on this will be found in our Material Data Sheets on the Internet (www.rf360jv.com/material). Should you have any more detailed questions, please contact our sales offices.
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